## FAST HIGH VOLTAGE TRANSISTOR SWITCHES

This new generation of BEHLKE high voltage switching modules utilize an advanced MOSFET technology with very low on-resistance, the so called Trench FET technology. The switching speed of those modern FET is slightly slower than that of a classical power FET, but is still much faster than that of any IGBT, which is preferably used to achieve low turn-on losses. The new MOSFET switches of series HTS-B combine very low dynamic switching losses with moderate turn-on losses and are a serious alternative to IGBT switches. Another important advantage compared to the fault sensitive IGBT is the positive temperature coefficient of the on-resistance, which makes the switch short circuit proof within the thermal limits. Furthermore overvoltage transients as well as voltage reversal respectively current reversal is less dangerous to MOSFET's than to IGBT's. Insofar these switching modules are well suitable for applications with high demands on operational safety even under worst conditions.

The switching modules incorporate all features of the well known HTS switch family: Easy handling, high reliability, low jitter and reproducible switching behaviour.

The switch is turned on by a positive going signal of 3 to 6 volts amplitude, provided the auxiliary power supply is permanently connected to the +5.00 VDC input. The on-time may simply be varied between 250 ns and infinity by the input control pulse width. An interference-proof driver circuit provides signal conditioning, auxiliary voltage monitoring, frequency limitation and temperature protection. In case of any false operating condition the switches turn off immediately and a fault signal is generated (TTL level). The high frequency burst operation ( $>10$ pulses $/ 100 \mu \mathrm{~s}$ ) requires the option HFB (connection of external buffer capacitors at the driver). For operation at higher frequencies than specified under $f_{(\max )}$ the option HFS must be used. In that case an internal DC/DC converter must be supported by an external supply of +180 VDC $( \pm 5 \%$, approx. 2-10 Watts depending on switching frequency).
Due to the high galvanic isolation the switches may simply be operated also in floating set-up's or in high-side circuits. Several housing options are available to meet individual constructional and power requirements. The standard plastic housing is used in low frequency applications with low average power dissipation. The plastic modules can additionally be fitted with non-isolated cooling fins (available as options CF, CF-X2 and CF-X3), which improves the max. Continuous Power Dissipation $\mathrm{P}_{\mathrm{d}(\max )}$ by approx. factor 10 with forced air ( $>4 \mathrm{~m} / \mathrm{s}$ ) or by factor 50 , if the switching modules are immersed in isolating cooling liquids (e.g. GALDEN HT200, flow rate $>0.1 \mathrm{~m} / \mathrm{s}$, standard cooling fins). Another cooling method is given by the use of the grounded cooling flange (option GCF and GCF-X2). In conjunction with an optional water cooling plate or any other high performance heatsink, maximum power dissipations in the range of 1 to 3 kW are possible, with larger customized cooling flanges even up to 6 kW .
The modules can be installed on a printed circuit board, but if operated under air conditions, the use of option PT-HV (pigtails for HV connection) is recommended, in order to ensure a sufficient creepage distance according to industrial standards. For detailed design recommendations please refer to the general instructions for use.

HTS 81-12-B $8.4 \mathrm{kV} / 125 \mathrm{~A}$ HTS 81-25-B $8.4 \mathrm{kV} / 250 \mathrm{~A}$


HTS 81-25-B
with option GCF

Patented Made in Germany

MOSFET
TECHNOLOGY

## Variable On-Time Very Low On-Resistance



## Basic Circuits



## Important EMC Design Hints

- Keep the wiring as short as possible and avoid large induction loop areas of the peak current carrying lines; the forward and return lines should be installed as closely as possible together Control and power circuit must not be mixed. Always keep the transformer principle in mind!
- Use shielded leads at the control side to minimize noise induction. Low impedance drivers with 5 Volt output swing (into 50 Ohm ) are required for driving long pulse transmission lines. Signal transmission lines must be terminated properly (e.g. by 50 Ohm ). The auxiliary power supply must be well decoupled by a sufficient buffer capacitor.
- This high speed switching module can generate extreme di/dt's and dv/dt's. Therfore it is not useful to operate the switch and its peripheric components without a shielded housing. Other electronics including power supplies (!) may be disturbed. Please note your local EMC / EMI regulations. Please also see our option offers for possible EMC / EMI relevant modifications.


## In this area input wiring control electronics only



I Input connection over long distance
, requires shielded cables with termination!

TECHNICAL DATA

| Specification | Symb. | Condition / Comment |  | HTS 81-12-B | HTS 81-25-B | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Operating Voltage | $\mathrm{V}_{\text {O(max) }}$ | $\mathrm{I}_{\text {off }}<100$ PADC |  | 8400 |  | VDC |
| Minimum Operating Voltage | $\mathrm{V}_{\text {(min) }}$ | Increased $\mathrm{t}_{\text {(on) }}$ and $\mathrm{t}_{\text {(roff) }}$ below $0.1 \times \mathrm{V}_{\text {O(max) }}$ |  | 0 |  | VDC |
| Typical Breakdown Voltage | $\mathrm{V}_{\mathrm{br}}$ | $\mathrm{I}_{\text {off }}>1 \mathrm{mADC}, \mathrm{T}_{\text {case }}=70^{\circ} \mathrm{C}$ |  | 8800 |  | VDC |
| Galvanic Isolation | $\mathrm{V}_{1}$ | Continuously S <br>  O <br>  O | Standard housing Option PT-HV Option ISO-80 | $\begin{aligned} & 15 \\ & 25 \\ & 80 \end{aligned}$ |  | kVDC |
| Maximum Peak Current | $\mathrm{I}_{\text {(max) }}$ | $\mathrm{T}_{\text {case }}=25^{\circ} \mathrm{C}$ $\mathrm{t}_{\mathrm{p}}<$ <br> $\mathrm{T}_{\text {fin }}=70^{\circ} \mathrm{C}^{*}$ $\mathrm{t}_{\mathrm{p}}<$ <br> ${ }^{\text {tmeasured at base }}$ $\mathrm{t}_{\mathrm{p}}<$ | 0 s, duty cycle <1\% ms , duty cycle $<10 \%$ ms , duty cycle $<10 \%$ | $\begin{aligned} & 125 \\ & 67 \\ & 52 \end{aligned}$ | $\begin{aligned} & 250 \\ & 135 \\ & 104 \\ & \hline \end{aligned}$ | ADC |
| Max. Continuous Load Current | IL | $\mathrm{T}_{\text {case }}=25^{\circ} \mathrm{C}$ Stan <br> $\mathrm{T}_{\text {flange }}=25^{\circ} \mathrm{C}$ Optio <br> $\mathrm{T}_{\text {tin }}=70^{\circ} \mathrm{C}$ Optio <br> ${ }^{*}$ measured at base Opt. | ard plastic case $C F$, fins in air $>4 \mathrm{~m} / \mathrm{s}$ CF, in Galden $\gg 0.1 \mathrm{~m} / \mathrm{s}$ CF, grounded cooling flange | $\begin{gathered} 2.1 \\ 7.1 \\ 14.6 \\ 20.3 \\ \hline \end{gathered}$ | $\begin{gathered} \hline 3.2 \\ 9.9 \\ 20.6 \\ 28.7 \end{gathered}$ | ADC |
| Static On-Resistance | $\mathrm{R}_{\text {stat }}$ | $\begin{array}{ll}\mathrm{T}_{\text {case }}=25^{\circ} \mathrm{C} & \begin{array}{l}0.1 \times \\ 1.0 \times\end{array} \\ & \end{array}$ |  | $\begin{aligned} & 1.3 \\ & 3.4 \end{aligned}$ | $\begin{gathered} 0.65 \\ 1.7 \end{gathered}$ | : |
| Maximum Off-State Current | $\mathrm{I}_{\text {ff }}$ | $0.8 \mathrm{x} \mathrm{V}_{\mathrm{o}}, \mathrm{T}_{\text {case }}=70^{\circ} \mathrm{C},<5 \mathrm{PA}$ leakage optionally available |  | 50 |  | PADC |
| Turn-On Delay Time | $\mathrm{t}_{\text {d(on) }}$ | @ $\mathrm{IP}_{\text {(max) }}$ |  | 160 | 190 | ns |
| Typical Turn-On Rise Time | $\mathrm{t}_{\text {r(on) }}$ | $\begin{aligned} & 0.1 \times \mathrm{V}_{\mathrm{O}}, 0.1 \times \mathrm{I}_{\mathrm{P}(\text { max })} \\ & 0.5 \times \mathrm{V}_{\mathrm{O}}, 0.1 \times \mathrm{P}_{\mathrm{P}_{\text {max }}} \\ & 0.8 \times \mathrm{V}_{\mathrm{O}}, 0.1 \times \mathrm{P}_{\mathrm{Pmax}} 0.8 \times \mathrm{V}_{0}, 1.0 \times \mathrm{P}_{\mathrm{P}_{(\text {max }}} \end{aligned}$ |  | $\begin{aligned} & 10 \\ & 12 \\ & 16 \\ & 28 \end{aligned}$ | $\begin{aligned} & 11 \\ & 12 \\ & 19 \\ & 33 \end{aligned}$ | ns |
| Typical Turn-Off Rise Time | $\mathrm{t}_{\text {(foff) }}$ | $0.8 \times \mathrm{V}_{\mathrm{O}}, 0.1 \times \mathrm{I}_{\mathrm{P} \text { (max), }}$, resistive load, $10-90 \%$ |  | 50 |  | ns |
| Minimum On-Time | $\mathrm{ton}_{\text {(min) }}$ | Lower $\mathrm{t}_{\text {on(min) }}$ on request |  | 18 |  | ns |
| Maximum On-Time | $\mathrm{ton}_{\text {(max) }}$ | Please note possible $\mathrm{P}_{\mathrm{d}(\text { max })}$ limitations |  | $\infty$ |  |  |
| Switch Recovery Time | $\mathrm{t}_{\mathrm{cc}}$ | $\mathrm{t}_{\mathrm{rc}}=$ minimum pulse spacing |  | 50 |  | ns |
| Typical Turn-On Jitter | $\mathrm{t}_{\text {jon) }}$ | $\mathrm{V}_{\text {aux }} / \mathrm{V}_{\mathrm{tr}}=5.0 \mathrm{VDC}$, fixed switching frequency |  | 300 |  | ps |
| Max. Switching Frequency | $\mathrm{f}_{\text {(max) }}$ | Pls. note possible Standard <br> $\mathrm{P}_{\mathrm{d}(\text { max })}$ limitations Opt. HFS, please consult factory |  | $\begin{gathered} 15 \\ 100 \\ \hline \end{gathered}$ | $\begin{aligned} & 10 \\ & 60 \\ & \hline \end{aligned}$ | kHz |
| Maximum Burst Frequency | $\mathrm{f}_{\mathrm{b}(\text { max })}$ | Use option HFB for $>5$ pulses within $100 \mu \mathrm{~s}$ |  | 2 |  | MHz |
| Maximum Continuous Power Dissipation | $\mathrm{P}_{\mathrm{d}(\text { max })}$ | $\mathrm{T}_{\text {case }}=25^{\circ} \mathrm{C}$ Standard plastic case <br> $\mathrm{T}_{\text {thang }}=25^{\circ} \mathrm{C}$ Option CF, fins in air $>4 \mathrm{~m} / \mathrm{s}$ <br> $\mathrm{T}_{\text {tin }}=70^{\circ} \mathrm{C}$ Option CF, in Galden $\square>0.1 \mathrm{~m} / \mathrm{s}$ <br> *measured at base Opt. GCF, grounded cooling flange |  | $\begin{gathered} \hline 18 \\ 168 \\ 722 \\ 1400 \end{gathered}$ |  | Watts |
| Linear Derating |  | $\mathrm{T}_{\text {case }}=25^{\circ} \mathrm{C}$ Standard plastic case <br> $\mathrm{T}_{\text {trange }}=25^{\circ} \mathrm{C}$ Option CF, fins in air $>4 \mathrm{~m} / \mathrm{s}$ <br> $\mathrm{T}_{\text {tin }}=70^{\circ} \mathrm{C}$ Option CF, in Galden $\square>0.1 \mathrm{~m} / \mathrm{s}$ <br> *measured at base Opt. GCF, grounded cooling flange |  | $\begin{gathered} 0.4 \\ 3.73 \\ 16.04 \\ 31.11 \end{gathered}$ |  | W/K |
| Operating Temperature Range | To | Extended temperature range on request |  | -40...70 |  | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {ST }}$ |  |  | -50... 90 |  | ${ }^{\circ} \mathrm{C}$ |
| Natural Capacitance | $\mathrm{C}_{\mathrm{N}}$ | Capacitance between switch poles at $\mathrm{V}_{\mathrm{O}(\text { max }}$ |  | 38 | 77 | pF |
| Coupling Capacitance | $\mathrm{C}_{\mathrm{c}}$ | HV side to GND  <br> or control side St <br> Op  | dard devices GCF, grounded cooling flange |  |  | pF |
| Diode Reverse Recovery Time | $\mathrm{t}_{\text {rc }}$ | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~A}, \mathrm{~T}_{\text {case }}=25^{\circ} \mathrm{C}$ MOSFET parasitic diode |  | 500 |  | ns |
| Diode Forward Voltage Drop | $\mathrm{V}_{\mathrm{F}}$ | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~A}, \mathrm{~T}_{\text {case }}=25^{\circ} \mathrm{C}$ | MOSFET parasitic diode | 11.2 |  | VDC |
| Auxiliary Supply Voltage | $\mathrm{V}_{\text {aux }}$ | r2\% stability recommended, max. tolerance r5\% |  | 5.00 |  | VDC |
| Auxiliary Supply Current | $\mathrm{I}_{\text {aux }}$ | @ $f_{\text {max }}$ |  | 60 |  | mADC |
| Control Signal | $\mathrm{V}_{\text {tr }}$ | > 3VDC recommended |  | 2... 6 |  | VDC |
| Fault Signal Output |  | TTL compatible, short circuit proof, L=Fault |  | $\mathrm{H}=4 \mathrm{~V}, \mathrm{~L}=0.5 \mathrm{~V}$ |  | VDC |
| Dimensions | LxWxH | Standard plastic case <br> Option FC, flat case <br> Option CF, non-isolated cooling fins, standard size Option GCF, grounded cooling flange |  | $\begin{gathered} 135 \times 64 \times 28 \\ 135 \times 64 \times 19 \\ 135 \times 64 \times 63 \\ 192 \times 100 \times 35 \end{gathered}$ |  | $\mathrm{mm}^{3}$ |
| Weight |  | Standard plastic case <br> Option FC, flat case <br> Option CF, non-isolated cooling fins, standard size <br> Option GCF, grounded cooling flange |  | $\begin{gathered} \hline 420 \\ 320 \\ 630 \\ 1450 \\ \hline \end{gathered}$ |  | g |

## Ordering Information

HTS 81-12-B Transistor switch, 8 kVDC, 125 Amps.
HTS 81-25-B Transistor switch, 8 kVDC, 250 Amps.
Option HFB High frequency burst
Option HFS High frequency switching
Option LP Low pass at control input (delay +50 ns )
Option S-TT Soft transition time for simplified EMC design
Option PT-HV Pigtails for HV connection

Option ISO-40 Galvanic isolation increased to 40 kVDC
Option ISO-80 Galvanic isolation increased to 80 kVDC
Option PIN-C Soldering pins instead of pigtail/plug as control connection
Option FC Flat plastic case, module height reduced to 19 mm
Option UL-94 Flame-retardant casting resin according to UL94-V0 Option CF Non-isolated cooling fins, standard size, 35 mm height Option GCF Grounded cooling flange, direct attachment to heat sink

